



### **DAC7541A**

# Low Cost 12-Bit CMOS Four-Quadrant Multiplying DIGITAL-TO-ANALOG CONVERTER

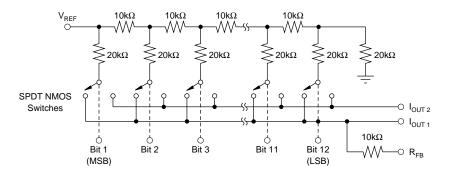
#### **FEATURES**

- FULL FOUR-QUADRANT MULTIPLICATION
- 12-BIT END-POINT LINEARITY
- DIFFERENTIAL LINEARITY ±1/2LSB MAX OVER TEMPERATURE
- MONOTONICITY GUARANTEED OVER TEMPERATURE
- TTL-/CMOS-COMPATIBLE
- SINGLE +5V TO +15V SUPPLY
- LATCH-UP RESISTANT
- 7521/7541/7541A REPLACEMENT
- PACKAGES: Plastic DIP, Plastic SOIC
- LOW COST

#### DESCRIPTION

The Burr-Brown DAC7541A is a low cost 12-bit, four-quadrant multiplying digital-to-analog converter. Laser-trimmed thin-film resistors on a monolithic CMOS circuit provide true 12-bit integral and differential linearity over the full specified temperature range.

DAC7541A is a direct, improved pin-for-pin replacement for 7521, 7541, and 7541A industry standard parts. In addition to a standard 18-pin plastic package, the DAC7541A is also available in a surface-mount plastic 18-pin SOIC.



Digital Inputs (DTL-/TTL-/CMOS-compatible) Logic: A switch is closed to  $I_{\text{OUT 1}}$  for its digital input in a "HIGH" state.

Switches shown for digital inputs "HIGH".

International Airport Industrial Park • Mailing Address: PO Box 11400 • Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd. • Tucson, AZ 85706

Tel: (520) 746-1111 • Twx: 910-952-1111 • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

#### **SPECIFICATIONS**

#### **ELECTRICAL**

At +25°C, +V<sub>DD</sub> = +12V or +15V,  $V_{REF}$  = +10V,  $V_{PIN \, 1}$  =  $V_{PIN \, 2}$  = 0V, unless otherwise specified.

|  |       | DAG                    | C7541A                           |             |   |  |  |  |  |
|--|-------|------------------------|----------------------------------|-------------|---|--|--|--|--|
| PARAMETER  | GRADE | T <sub>A</sub> = +25°C | $T_{A} = T_{MAX}, T_{MIN}^{(1)}$ | UNITS       | TEST CONDITIONS/COMMENTS                                    |  |  |  |  |
| ACCURACY   |       |                        |                                  |             |   |  |  |  |  |
| Resolution   | All   | 12                     | 12                               | Bits        |   |  |  |  |  |
| Relative Accuracy                                  | J     | ±1                     | ±1                               | LSB max     | $\pm 1$ LSB = $\pm 0.024\%$ of FSR.                         |  |  |  |  |
|  | K     | ±1/2                   | ±1/2                             | LSB max     | $\pm 1/2$ LSB = $\pm 0.012\%$ of FSR.                       |  |  |  |  |
| Differential Non-linearity                         | J     | ±1                     | ±1                               | LSB max     | All grades guaranteed monotonic to 12 bits,                 |  |  |  |  |
|  | K     | ±1/2                   | ±1/2                             | LSB max     | T <sub>MIN</sub> to T <sub>MAX</sub> .                      |  |  |  |  |
| Gain Error   | J     | ±6                     | ±8                               | LSB max     | Measured using internal R <sub>FB</sub> and includes effect |  |  |  |  |
|  | K     | ±1                     | ±3                               | LSB max     | of leakage current and gain T.C.                            |  |  |  |  |
|  |       |                        |                                  |             | Gain error can be trimmed to zero.                          |  |  |  |  |
| Gain Temperature Coefficient                       |       |                        |                                  |             |   |  |  |  |  |
| (ΔGain/ΔTemperature)                               | ALL   | _                      | 5                                | ppm/°C max  | Typical value is 2ppm/°C.                                   |  |  |  |  |
| Output Leakage Current: Out <sub>1</sub> (Pin 1)   | J, K  | ±5                     | ±10                              | nA max      | All digital inputs = 0V.                                    |  |  |  |  |
| Out <sub>2</sub> (Pin 2)                           | J, K  | ±5                     | ±10                              | nA max      | All digital inputs = $V_{DD}$ .                             |  |  |  |  |
| REFERENCE INPUT                                    |       |                        |                                  |             |   |  |  |  |  |
| Voltage (Pin 17 to GND)                            | All   | -10/+10                | -10/+10                          | V min/max   |   |  |  |  |  |
| Input Resistance (Pin 17 to GND)                   | All   | 7-18                   | 7-18                             | kΩ min/max  |   |  |  |  |  |
|  |       |                        |                                  |             | Typical input resistance = $11kΩ$ .                         |  |  |  |  |
|  |       |                        |                                  |             | Typical input resistance temperature coefficient is         |  |  |  |  |
|  |       |                        |                                  |             | −50ppm/°C.  |  |  |  |  |
| DIGITAL INPUTS                                     |       |                        |                                  |             |   |  |  |  |  |
| V <sub>IN</sub> (Input HIGH Voltage)               | All   | 2.4                    | 2.4                              | V min       |   |  |  |  |  |
| V <sub>II</sub> (Input LOW Voltage)                | All   | 0.8                    | 0.8                              | V max       |   |  |  |  |  |
| I <sub>IN</sub> (Input Current)                    | All   | ±1                     | ±1                               | μA max      | Logic inputs are MOS gates.                                 |  |  |  |  |
|  |       |                        |                                  |             | I <sub>IN</sub> typ (25°C) = 1nA                            |  |  |  |  |
| C <sub>IN</sub> (Input Capacitance) <sup>(2)</sup> | All   | 8                      | 8                                | pF max      | $V_{IN} = 0V$   |  |  |  |  |
| POWER SUPPLY REJECTION                             |       |                        |                                  |             |   |  |  |  |  |
| $\Delta Gain/\Delta V_{DD}$                        | All   | ±0.01                  | ±0.02                            | % per % max | V <sub>DD</sub> = +11.4V to +16V                            |  |  |  |  |
| POWER SUPPLY                                       |       |                        |                                  |             |   |  |  |  |  |
| V <sub>DD</sub> Range                              | All   | +5 to +16              | +5 to +16                        | V min to    | Accuracy is not guaranteed over this range.                 |  |  |  |  |
|  |       |                        |                                  | V max       |   |  |  |  |  |
| I <sub>DD</sub>                                    | All   | 2                      | 2                                | mA max      | All digital inputs V <sub>IL</sub> or V <sub>IN</sub> .     |  |  |  |  |
|  | All   | 100                    | 500                              | μA max      | All digital inputs 0V or V <sub>DD</sub> .                  |  |  |  |  |

NOTES: (1) Temperature ranges are: =  $0^{\circ}$ C to +  $70^{\circ}$ C for JP, KP, JU and KU versions. (2) Guaranteed by design but not production tested.

#### **AC PERFORMANCE CHARACTERISTICS**

These characteristics are included for design guidance only and are not production tested.  $V_{DD}$  = +15V,  $V_{REF}$  = +10V except where stated,  $V_{PIN 1}$  =  $V_{PIN 2}$  = 0V, output amp is OPA606 except where stated.

|  |       | DAC                    | 7541A                     |           |   |
|--|-------|------------------------|---------------------------|-----------|---|
| PARAMETER  | GRADE | T <sub>A</sub> = +25°C | $T_A = T_MAX,T_MIN^{(1)}$ | UNITS     | TEST CONDITIONS/COMMENTS  |
| PROPAGATION DELAY (from Digital Input change to 90% of |       |                        |                           |           | Out <sub>1</sub> Load = $100\Omega$ , $C_{EXT} = 13pF$ .  |
| final Analog Output)                                   | All   | 100                    | _                         | ns typ    | Digital Inputs = 0V to $V_{DD}$ or $V_{DD}$ to 0V.  |
| DIGITAL-TO-ANALOG GLITCH IMPULSE                       | All   | 1000                   | _                         | nV-s typ  | $V_{REF}$ = 0V, all digital inputs 0V to $V_{DD}$ or $V_{DD}$ to 0V. Measured using OPA606 as output amplifier. |
| MULTIPLYING FEEDTHROUGH<br>ERROR                       |       |                        |                           |           |   |
| (V <sub>REF</sub> to Out <sub>1</sub> )                | All   | 1.0                    | _                         | mVp-p max | $V_{REF} = \pm 10V$ , 10kHz sine wave.  |
| OUTPUT CURRENT SETTLING TIME                           |       |                        |                           |           |   |
|  | All   | 0.6                    | _                         | μs typ    | To 0.01% of Full Scale Range.   |
|  | All   | 1.0                    | _                         | μs max    | Out <sub>1</sub> Load = $100\Omega$ , $C_{EXT} = 13pF$ .<br>Digital Inputs: 0V to $V_{DD}$ or $V_{DD}$ to 0V.   |
| OUTPUT CAPACITANCE                                     |       |                        |                           |           |   |
| C <sub>OUT 1</sub> (Pin 1)                             | All   | 100                    | 100                       | pF max    | Digital Inputs = V <sub>IH</sub>  |
| C <sub>OUT 2</sub> (Pin 2)                             | All   | 60                     | 60                        | pF max    | Digital Inputs = V <sub>IH</sub>  |
| C <sub>OUT 1</sub> (Pin 1)                             | All   | 70                     | 70                        | pF max    | Digital Inputs = V <sub>IL</sub>  |
| C <sub>OUT 2</sub> (Pin 2)                             | All   | 100                    | 100                       | pF max    | Digital Inputs = V <sub>IL</sub>  |

NOTE: (1) Temperature ranges are: =  $0^{\circ}$ C to +  $70^{\circ}$ C for JP, KP, JU and KU versions.



#### ABSOLUTE MAXIMUM RATINGS(1)

| +17V                   |
|------------------------|
| +25V                   |
| ±25V                   |
| 0.4V, V <sub>DD</sub>  |
| –0.4V, V <sub>DD</sub> |
|                        |
| 450mW                  |
| 6mW/°C                 |
| +300°C                 |
| +125°C                 |
|                        |

NOTE: (1) Stresses above those listed above may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other condition above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# ELECTROSTATIC DISCHARGE SENSITIVITY

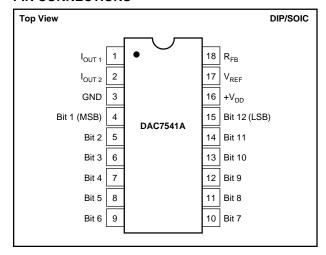
The DAC7541A is an ESD (electrostatic discharge) sensitive device. The digital control inputs have a special FET structure, which turns on when the input exceeds the supply by 18V, to minimize ESD damage. However, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. When not in use, devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are removed.

#### **BURN-IN SCREENING**

Burn-in screening is an option available for the models in the Ordering Information table. Burn-in duration is 160 hours at the indicated temperature (or equivalent combination of time and temperature).

All units are tested after burn-in to ensure that grade specifications are met. To order burn-in, add "-BI" to the base model number.

#### PIN CONNECTIONS



#### **PACKAGE INFORMATION**

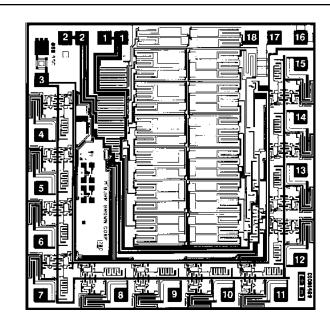
| MODEL                  | PACKAGE      | PACKAGE DRAWING<br>NUMBER <sup>(1)</sup> |
|------------------------|--------------|--|
| DAC7541JP              | Plastic DIP  | 218                                      |
| DAC7541KP              | Plastic DIP  | 218                                      |
| DAC7541JU<br>DAC7541KU | Plastic SOIC | 219<br>219                               |
| DAC7541JP-BI           | Plastic DIP  | 218                                      |
| DAC7541KP-BI           | Plastic DIP  | 218                                      |

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

#### ORDERING INFORMATION

| MODEL  | PACKAGE  | TEMPERATURE<br>RANGE   | RELATIVE<br>ACCURACY (LSB) | GAIN ERROR (LSB)                            |  |  |  |  |
|--|--|--|----------------------------|---|--|--|--|--|
| DAC7541AJP<br>DAC7541AKP<br>DAC7541AJU<br>DAC7541AKU | Plastic DIP<br>Plastic DIP<br>Plastic SOIC<br>Plastic SOIC | 0°C to +70°C<br>0°C to +70°C<br>0°C to +70°C<br>0°C to +70°C | ±1<br>±1/2<br>±1<br>±1/2   | ±6<br>±1<br>±6<br>±1                        |  |  |  |  |
| BURN-IN SCREENING OPTION See text for details.       |  |  |                            |   |  |  |  |  |
| MODEL  | PACKAGE  | TEMPERATURE<br>RANGE   | RELATIVE<br>ACCURACY (LSB) | BURN-IN TEMP.<br>(160 Hours) <sup>(1)</sup> |  |  |  |  |
| DAC7541AJP-BI<br>DAC7541AKP-BI                       | Plastic DIP<br>Plastic DIP                                 | 0°C to +70°C<br>0°C to +70°C                                 | ±1<br>±1/2                 | +85°C<br>+85°C                              |  |  |  |  |

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.



| PAD | FUNCTION          | PAD | FUNCTION              |
|-----|-------------------|-----|-----------------------|
| 1   | I <sub>OUT1</sub> | 10  | Bit 7                 |
| 2   | I <sub>OUT2</sub> | 11  | Bit 8                 |
| 3   | GND               | 12  | Bit 9                 |
| 4   | Bit 1 (MSB)       | 13  | Bit 10                |
| 5   | Bit 2             | 14  | Bit 11                |
| 6   | Bit 3             | 15  | Bit 12 (LSB)          |
| 7   | Bit 4             | 16  | +V <sub>DD</sub>      |
| 8   | Bit 5             | 17  | V <sub>REF</sub>      |
| 9   | Bit 6             | 18  | R <sub>FEEDBACK</sub> |

Substrate Bias: Isolated.

NC: No Connection.

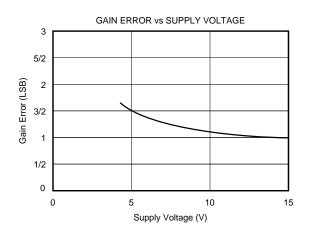
#### **MECHANICAL INFORMATION**

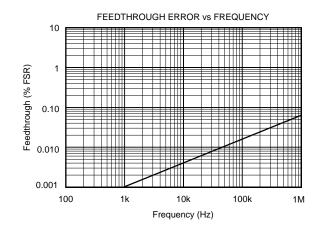
|               | MILS (0.001") | MILLIMETERS       |
|---------------|---------------|-------------------|
| Die Size      | 104 x 105 ±5  | 2.64 x 2.67 ±0.13 |
| Die Thickness | 20 ±3         | 0.51 ±0.08        |
| Min. Pad Size | 4 x 4         | 0.10 x 0.10       |
| Metalization  |               | Aluminum          |

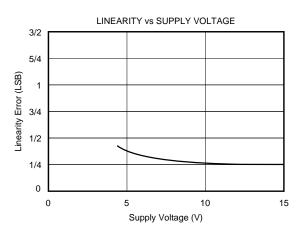
**DIE TOPOLOGY DAC7541A** 

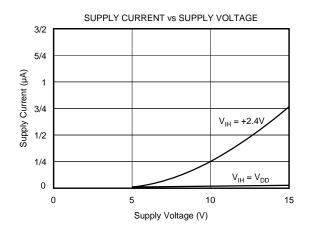
#### **TYPICAL PERFORMANCE CURVES**

 $T_A = +25^{\circ}C$ ,  $V_{DD} = +15V$ , unless otherwise noted.











# DISCUSSION OF SPECIFICATIONS

#### **RELATIVE ACCURACY**

This term (also known as linearity) describes the transfer function of analog output to digital input code. The linearity error describes the deviation from a straight line between zero and full scale.

#### **DIFFERENTIAL NONLINEARITY**

Differential nonlinearity is the deviation from an ideal 1LSB change in the output, from one adjacent output state to the next. A differential nonlinearity specification of  $\pm 1.0$ LSB guarantees monotonicity.

#### **GAIN ERROR**

Gain error is the difference in measure of full-scale output versus the ideal DAC output. The ideal output for the DAC7541A is -(4095/4096) X ( $V_{REF}$ ). Gain error may be adjusted to zero using external trims.

#### **OUTPUT LEAKAGE CURRENT**

The measure of current which appears at Out<sub>1</sub> with the DAC loaded with all zeros, or at Out<sub>2</sub> with the DAC loaded with all ones.

#### MULTIPLYING FEEDTHROUGH ERROR

This is the AC error output due to capacitive feedthrough from  $V_{REF}$  to  $Out_1$  with the DAC loaded with all zeros. This test is performed at 10kHz.

#### **OUTPUT CURRENT SETTLING TIME**

This is the time required for the output to settle to a tolerance of  $\pm 0.5$ LSB of final value from a change in code of all zeros to all ones, or all ones to all zeros.

#### **PROPAGATION DELAY**

This is the measure of the delay of the internal circuitry and is measured as the time from a digital code change to the point at which the output reaches 90% of final value.

#### **DIGITAL-TO-ANALOG GLITCH IMPULSE**

This is the measure of the area of the glitch energy measured in nV-seconds. Key contributions to glitch energy are digital word-bit timing differences, internal circuitry timing differences, and charge injected from digital logic.

#### MONOTONICITY

Monotonicity assures that the analog output will increase or stay the same for increasing digital input codes. The DAC7541A is guaranteed monotonic to 12 bits.

#### POWER SUPPLY REJECTION

Power supply rejection is the measure of the sensitivity of the output (full scale) to a change in the power supply voltage.

#### CIRCUIT DESCRIPTION

The DAC7541A is a 12-bit multiplying D/A converter consisting of a highly stable thin-film R-2R ladder network and 12 pairs of current steering switches on a monolithic chip. Most applications require the addition of a voltage or current reference and an output operational amplifier.

A simplified circuit of the DAC7541A is shown in Figure 1. The R-2R inverted ladder binarily divides the input currents that are switched between  $I_{OUT\ 1}$  and  $I_{OUT\ 2}$  bus lines. This switching allows a constant current to be maintained in each ladder leg independent of the input code.

The input resistance at  $V_{REF}$  (Figure 1) is always equal to  $R_{LDR}$  ( $R_{LDR}$  is the R/2R ladder characteristic resistance and is equal to value "R"). Since  $R_{IN}$  at the  $V_{REF}$  pin is constant, the reference terminal can be driven by a reference voltage or a reference current, AC or DC, of positive or negative polarity.

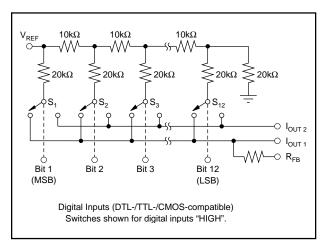


FIGURE 1. Simplified DAC Circuit.

#### **EQUIVALENT CIRCUIT ANALYSIS**

Figures 2 and 3 show the equivalent circuits for all digital inputs low and high, respectively. The reference current is switched to  $I_{OUT\ 2}$  when all inputs are low and  $I_{OUT\ 1}$  when inputs are high. The  $I_L$  current source is the combination of surface and junction leakages to the substrate; the 1/4096 current source represents the constant one-bit current drain through the ladder terminal.

## DYNAMIC PERFORMANCE Output Impedance

The output resistance, as in the case of the output capacitance, is also modulated by the digital input code. The resistance looking back into the  $I_{OUT\ 1}$  terminal may be anywhere between  $10k\Omega$  (the feedback resistor alone when all digital inputs are low) and  $7.5k\Omega$  (the feedback resistor in parallel with approximately  $30k\Omega$  of the R-2R ladder network resistance when any single bit logic is high). The static accuracy and dynamic performance will be affected by this modulation. The gain and phase stability of the output



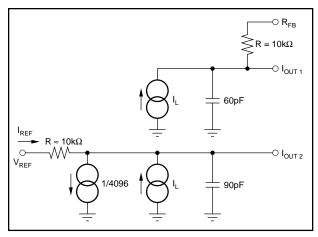


FIGURE 2. DAC7541A Equivalent Circuit (All inputs LOW).

amplifier, board layout, and power supply decoupling will all affect the dynamic performance of the DAC7541A. The use of a compensation capacitor may be required when high-speed operational amplifiers are used. It may be connected across the amplifier's feedback resistor to provide the necessary phase compensation to critically dampen the output. See Figures 4 and 6.

#### **APPLICATIONS**

#### OP AMP CONSIDERATIONS

The input bias current of the op amp flows through the feedback resistor, creating an error voltage at the output of the op amp. This will show up as an offset through all codes of the transfer characteristics. A low bias current op amp such as the OPA606 is recommended.

Low offset voltage and  $V_{OS}$  drift are also important. The output impedance of the DAC is modulated with the digital code. This impedance change (approximately  $10k\Omega$  to  $30k\Omega$ ) is a change in closed-loop gain to the op amp. The result is that  $V_{OS}$  will be multiplied by a factor of one to two depending on the code. This shows up as a linearity error. Offset can be adjusted out using Figure 4. Gain may be adjusted using Figure 5.

## UNIPOLAR BINARY OPERATION (Two-Quadrant Multiplication)

Figure 4 shows the analog circuit connections required for unipolar binary (two-quadrant multiplication) operation. With a DC reference voltage or current (positive or negative polarity) applied at pin 17, the circuit is a unipolar D/A converter. With an AC reference voltage or current, the circuit provides two-quadrant multiplication (digitally controlled attenuation). The input/output relationship is shown in Table I.

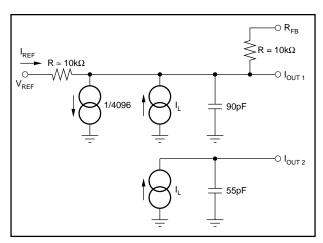


FIGURE 3. DAC7541A Equivalent Circuit (All inputs HIGH).

| BINARY IN | PUT     | ANALOG OUTPUT                 |
|-----------|---------|-------------------------------|
| MSB       | LSB     |                               |
| 1111 11   | 11 1111 | -V <sub>REF</sub> (4095/4096) |
| 1000 00   | 00 0000 | -V <sub>RFF</sub> (2048/4096) |
| 0000 00   | 00 0001 | -V <sub>REF</sub> (1/4096)    |
| 0000 00   | 00 0000 | 0V                            |

TABLE I. Unipolar Codes.

 $C_1$  phase compensation (10 to 25pF) in Figure 4 may be required for stability when using high speed amplifiers.  $C_1$  is used to cancel the pole formed by the DAC internal feedback resistance and output capacitance at  $Out_1$ .

 $R_1$  in Figure 5 provides full scale trim capability—load the DAC register to 1111 1111 1111, adjust  $R_1$  for  $V_{OUT} = -V_{REF} \, (4095/4096).$  Alternatively, full scale can be adjusted by omitting  $R_1$  and  $R_2$  and trimming the reference voltage magnitude.

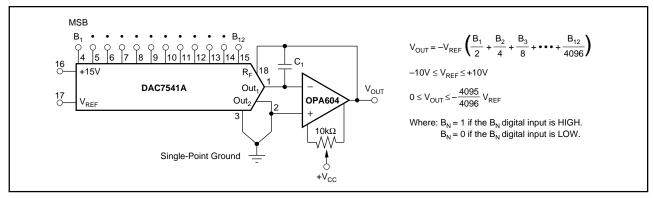
#### **BIPOLAR FOUR-QUADRANT OPERATION**

Figure 6 shows the connections for bipolar four-quadrant operation. Offset can be adjusted with the  $A_1$  to  $A_2$  summing resistor, with the input code set to 1000 0000 0000. Gain may be adjusted by varying the feedback resistor of  $A_2$ . The input/output relationship is shown in Table II.

| BINARY INI | PUT     | ANALOG OUTPUT                 |
|------------|---------|-------------------------------|
| MSB        | LSB     |                               |
| 1111 11    | 11 1111 | +V <sub>REF</sub> (2047/2048) |
| 1000 00    | 00 0000 | 0V                            |
| 0111 11    | 11 1111 | -V <sub>REF</sub> (1/2048)    |
| 0000 00    | 00 0000 | -V <sub>REF</sub> (2048/2048) |

TABLE II. Bipolar Codes.





 $FIGURE\ 4.\ Basic\ Connection\ With\ Op\ Amp\ V_{OS}\ Adjust:\ Unipolar\ (two-quadrant)\ Multiplying\ Configuration.$ 

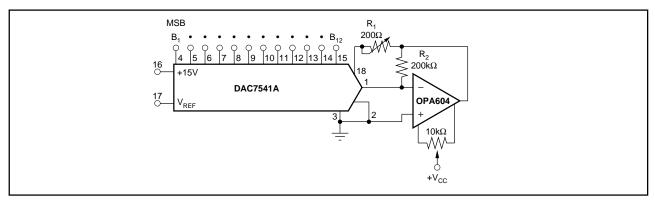
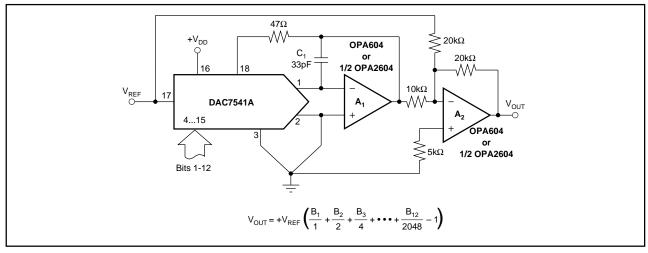


FIGURE 5. Basic Connection With Gain Adjust (allows adjustment up or down).



7

FIGURE 6. Bipolar Four-Quadrant Multiplier.

#### **DIGITALLY CONTROLLED GAIN BLOCK**

The DAC7541A may be used in a digitally controlled gain block as shown in Figure 7. This circuit gives a range of gain from one (all bits = one) to 4096 (LSB = one). The transfer function is:

$$V_{OUT} = \frac{-V_{IN}}{\left(\frac{B_1}{2} + \frac{B_2}{4} + \frac{B_3}{8} + \bullet \bullet \bullet + \frac{B_{12}}{4096}\right)}$$

All bits off is an illegal state, as division by zero is impossible (no op amp feedback). Also, errors increase as gain increases, and errors are minimized at major carries (only one bit on at a time).

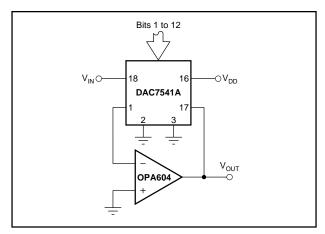


FIGURE 7. Digitally Programmable Gain Block.





ti.com 8-May-2008

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp (3)   |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|---------------------|
| DAC7541AJP       | ACTIVE                | PDIP            | N                  | 18   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | N / A for Pkg Type  |
| DAC7541AJPG4     | ACTIVE                | PDIP            | N                  | 18   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | N / A for Pkg Type  |
| DAC7541AJU       | ACTIVE                | SOP             | DTC                | 18   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |
| DAC7541AJUG4     | ACTIVE                | SOP             | DTC                | 18   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |
| DAC7541AKP       | ACTIVE                | PDIP            | N                  | 18   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | N / A for Pkg Type  |
| DAC7541AKPG4     | ACTIVE                | PDIP            | N                  | 18   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | N / A for Pkg Type  |
| DAC7541AKU       | ACTIVE                | SOP             | DTC                | 18   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |
| DAC7541AKU/1K    | ACTIVE                | SOP             | DTC                | 18   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |
| DAC7541AKU/1KG4  | ACTIVE                | SOP             | DTC                | 18   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |
| DAC7541AKUG4     | ACTIVE                | SOP             | DTC                | 18   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-3-260C-168 HR |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



#### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

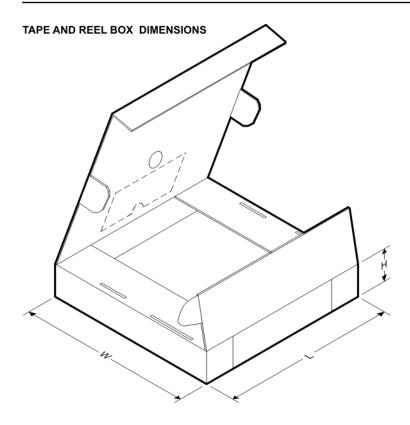
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device        |     | Package<br>Drawing |    |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| DAC7541AKU/1K | SOP | DTC                | 18 | 1000 | 330.0                    | 24.4                     | 10.9    | 12.0    | 2.7     | 12.0       | 24.0      | Q1               |





#### \*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DAC7541AKU/1K | SOP          | DTC             | 18   | 1000 | 346.0       | 346.0      | 41.0        |

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

#### **Products Amplifiers** amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

| Applications       |                           |  |  |  |
|--------------------|---------------------------|--|--|--|
| Audio              | www.ti.com/audio          |  |  |  |
| Automotive         | www.ti.com/automotive     |  |  |  |
| Broadband          | www.ti.com/broadband      |  |  |  |
| Digital Control    | www.ti.com/digitalcontrol |  |  |  |
| Medical            | www.ti.com/medical        |  |  |  |
| Military           | www.ti.com/military       |  |  |  |
| Optical Networking | www.ti.com/opticalnetwork |  |  |  |
| Security           | www.ti.com/security       |  |  |  |
| Telephony          | www.ti.com/telephony      |  |  |  |
| Video & Imaging    | www.ti.com/video          |  |  |  |
| Wireless           | www.ti.com/wireless       |  |  |  |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated